Unit: mm

TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOSVI-H)

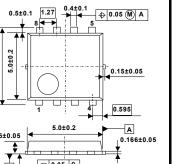
# **TPCA8028-H**

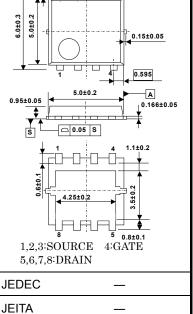
High-Efficiency DC/DC Converter Applications Notebook PC Applications Portable Equipment Applications

- Small footprint due to a small and thin package
- High-speed switching
- Small gate charge: QSW = 20 nC (typ.)
- Low drain-source ON-resistance: RDS (ON) = 2.0 m $\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 166 \text{ S (typ.)}$
- Low leakage current:  $I_{DSS} = 10 \mu A \text{ (max) (V}_{DS} = 30 \text{ V)}$
- Enhancement mode:  $V_{th} = 1.3 \text{ to } 2.3 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

#### **Absolute Maximum Ratings (Ta = 25°C)**

Characte	eristic	Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	30	V	
Drain-gate voltage (R	$R_{GS} = 20 \text{ k}\Omega$	$V_{DGR}$	30	V	
Gate-source voltage		$V_{GSS}$	±20	V	
Drain current	DC (Note 1)	ΙD	50	А	
Drain current	Pulsed (Note 1)	$I_{DP}$	150 45		
Drain power dissipation	on (Tc=25°C)	$P_{D}$	45	W	
Drain power dissipation	on (t = 10 s) (Note 2a)	$P_{D}$	2.8	W	
Drain power dissipation	on (t = 10 s) (Note 2b)	P <sub>D</sub>	1.6	W	
Single-pulse avalance	he energy (Note 3)	E <sub>AS</sub>	325	mJ	
Avalanche current		I <sub>AR</sub>	50	Α	
Repetitive avalanche	energy [c=25°C) (Note 4)	E <sub>AR</sub>	4.03	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature	range	T <sub>stg</sub>	-55 to 150	°C	



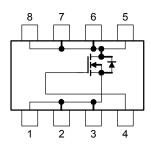


2-5Q1A

Weight: 0.069 g (typ.)

**TOSHIBA** 

### **Circuit Configuration**



Note: For Notes 1 to 4, refer to the next page.

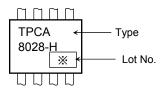
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

#### **Thermal Characteristics**

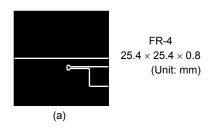
Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	R <sub>th (ch-c)</sub>	2.78	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R <sub>th (ch-a)</sub>	44.6	°C/W
Thermal resistance, channel to ambient $(t = 10 \text{ s})$ (Note 2b)	R <sub>th (ch-a)</sub>	78.1	°C/W

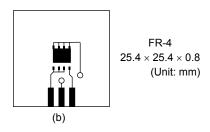
### Marking (Note 5)



Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Device mounted on a glass-epoxy board

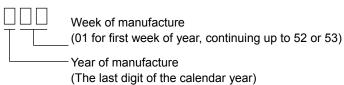




Note 3:  $V_{DD} = 24~V,~T_{Ch} = 25^{\circ}C$  (initial), L = 100  $\mu H,~R_G = 25~\Omega,~I_{AR} = 50~A$ 

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: \* Weekly code: (Three digits)



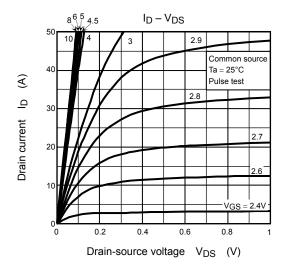
## **Electrical Characteristics (Ta = 25°C)**

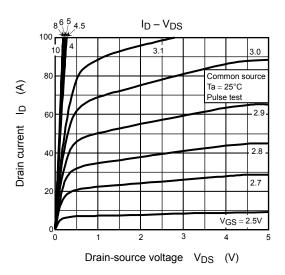
Ch	aracteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA
Drain cutoff curre	ent	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	_	_	10	μА
Drain-source bre	akdown voltago	V (BR) DSS	$I_D = 10$ mA, $V_{GS} = 0$ V	30	_	_	V
Dialii-Source bre	akuowii voitage	V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	15	- ±100 - 10 - 10 2.3 2.3 3.2 2.0 2.8 166 - 6000 7800 380 610 1100 - 1.5 5.0 - 16 9.8 - 71 88 - 46 - 46	V	
Gate threshold ve	oltage	V <sub>th</sub>	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	1.3	_	2.3	٧
Drain-source ON-resistance		Pro (OV)	$V_{GS} = 4.5 \text{ V}, I_D = 25 \text{ A}$	_	2.3	3.2	- mΩ
Diain-source Oiv	-resistance	R <sub>DS</sub> (ON)	$V_{GS} = 10 \text{ V}, I_D = 25 \text{ A}$	—     —     10       30     —     —       15     —     —       1.3     —     2.3       —     2.0     2.8       83     166     —       —     6000     7800       —     380     610       —     1100     —       —     1.0     1.5       —     5.0     —       —     16     —       —     9.8     —       —     71     —       —     88     —	11122		
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 25 \text{ A}$	83	166	_	S
Input capacitance	t capacitance C <sub>iss</sub>			_	6000	7800	
Reverse transfer	capacitance	C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	380	610	pF
Output capacitance		Coss		_	1100	_	
Gate resistance		Rg	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	1.0	1.5	Ω
Cuitobing time	Rise time	t <sub>r</sub>	V <sub>GS</sub> 10 V	_	5.0	_	ns
	Turn-on time	t <sub>on</sub>		_	16	_	
Switching time	Fall time	t <sub>f</sub>	RL = 0.	_	9.8	_	115
	Turn-off time	t <sub>off</sub>	$V_{DD} \simeq 15 \text{ V}$ Duty $\leq 1\%$ , $t_W = 10 \mu\text{s}$	_	71	_	
Total gate charge	otal gate charge		$V_{DD} \simeq 24~V,~V_{GS} = 10~V,~I_D = 50~A$	_	88	_	
(gate-source plus	s gate-drain)	Qg	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 50 \text{ A}$	_	46	46 —	
Gate-source charge 1		Q <sub>gs1</sub>	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$	_	16	_	nC
Gate-drain ("Miller") charge		Q <sub>gd</sub>		_	12	_	
Gate switch char	ge	Q <sub>SW</sub>		_	20	_	

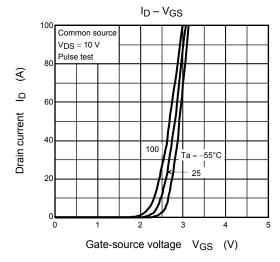
## **Source-Drain Ratings and Characteristics (Ta = 25°C)**

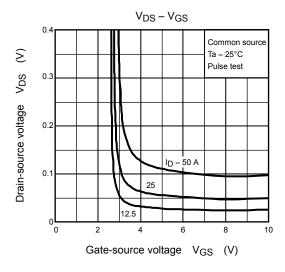
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit	
Drain reverse current	Pulse	(Note 1)	I <sub>DRP</sub>	_	_	_	150	Α
Forward voltage (diode)			V <sub>DSF</sub>	I <sub>DR</sub> = 50 A, V <sub>GS</sub> = 0 V	_	_	-1.2	V

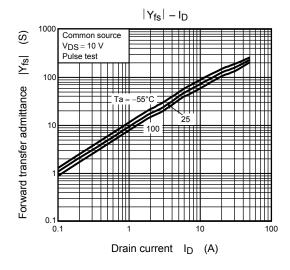
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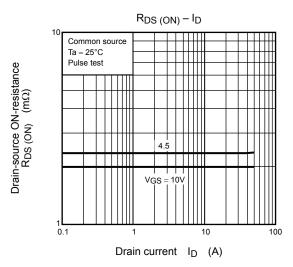


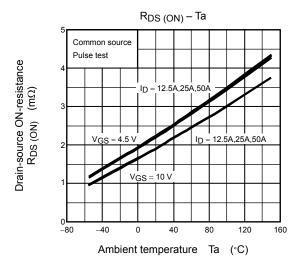


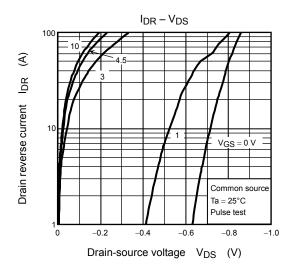


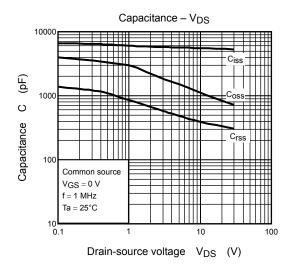


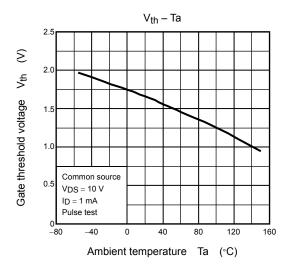


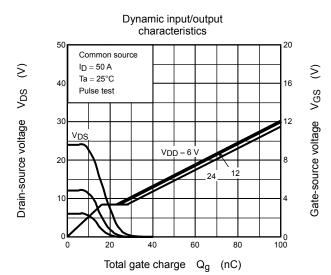




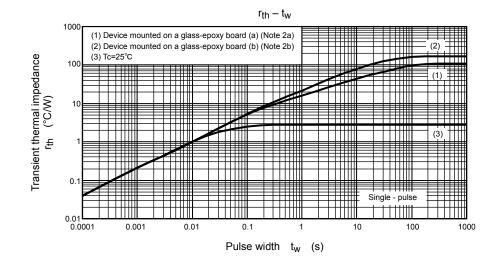


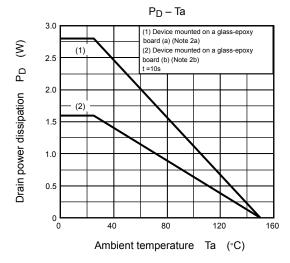


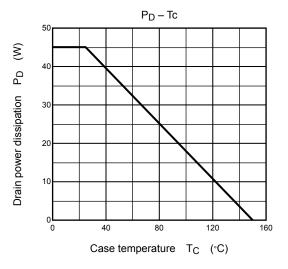


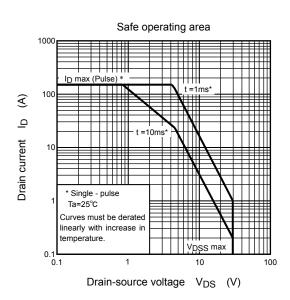


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